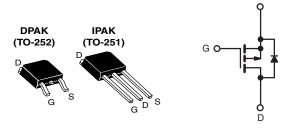


IRFR9220, IRFU9220, SiHFR9220, SiHFU9220

Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	- 200					
R _{DS(on)} (Ω)	V _{GS} = - 10 V 1.5					
Q _g (Max.) (nC)	20					
Q _{gs} (nC)	3.3					
Q _{gd} (nC)	11					
Configuration	Single					



P-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Surface Mount (IRFR9220, SiHFR9220)
- Straight Lead (IRFUFU9220, SiHFU9220)
- Available in Tape and Reel
- P-Channel
- Fast Switching
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

Third power MOSFETs technology is the key to Vishay advanced line of Power MOSFET transistors. The efficient geometry and unique processing of the Power MOSFETs design achieve very low on-state resistance combined with high transconductance and extreme device ruggedness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION								
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)			
Lead (Pb)-free and Halogen-free	SiHFR9220-GE3	SiHFR9220TRL-GE3ª	SiHFR9220TRR-GE3ª	SiHFR9220TR-GE3ª	SiHFU9220-GE3			
Lead (Pb)-free	IRFR9220PbF	IRFR9220TRLPbFa	IRFR9220TRRPbF ^a	IRFR9220TRPbF ^a	IRFU9220PbF			
	SiHFR9220-E3	SiHFR9220TL-E3 ^a	SiHFR9220TR-E3 ^a	SiHFR9220T-E3 ^a	SiHFU9220-E3			

Note

a. See device orientation.

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	- 200	v	
Gate-Source Voltage			V _{GS}	± 20	v
Continuous Drain Current	– I _D	- 3.6			
Continuous Drain Current	I _D	- 2.3	А		
Pulsed Drain Current ^a			I _{DM}	- 14	
Linear Derating Factor			0.33	M/90	
Linear Derating Factor (PCB Mount) ^e			0.020	W/°C	
Single Pulse Avalanche Energy ^b		E _{AS}	310	mJ	
Repetitive Avalanche Current ^a			I _{AR}	- 3.6	А
Repetitive Avalanche Energy ^a			E _{AR}	4.2	mJ
Maximum Power Dissipation	5 °C	D	42	w	
Maximum Power Dissipation (PCB Mount)e	P _D	2.5	v		
Peak Diode Recovery dV/dt ^c	dV/dt	- 5.0	V/ns		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature) ^d	0 s		260		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

 $\begin{array}{l} V_{DD} = -50 \text{ V}, \text{ Starting } T_J = 25 \ ^\circ\text{C}, \ L = 35 \ ^\text{mH}, \ R_g = 25 \ \Omega, \ I_{AS} = -3.6 \ \text{A} \ (\text{see fig. 12}). \\ I_{SD} \leq -3.9 \ \text{A}, \ dI/dt \leq 95 \ ^\text{A}/\mu\text{s}, \ V_{DD} \leq V_{DS}, \ T_J \leq 150 \ ^\circ\text{C}. \end{array}$ b.

c.

d.

When mounted on 1" square PCB (FR-4 or G-10 material). e.

S13-0166-Rev. E, 04-Feb-13

Available



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THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-	-	110				
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	50	°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	3.0				

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

SPECIFICATIONS (T _J = 25 °C, u PARAMETER	SYMBOL	,	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	OTMBOL			IVIII V.			
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	0 V, I _D = - 250 μA	- 200	-	_	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	40	e to 25 °C, I _D = - 1 mA	-	- 0.22	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}		V _{GS} , I _D = - 250 μA	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}	_	$V_{GS} = \pm 20 V$	-	-	± 100	nA
Ĵ		V _{DS} =	- 200 V, V _{GS} = 0 V	-	-	- 100	
Zero Gate Voltage Drain Current	I _{DSS}	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	-	- 500	μA		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 2.2 A ^b	-	-	1.5	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	- 50 V, I _D = - 2.2 A	1.1	-	-	S
Dynamic							
Input Capacitance	Ciss		$V_{ee} = 0.V$	-	340	-	
Output Capacitance	C _{oss}		$V_{DS} = -25 V,$	-	110	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1	.0 MHz, see fig. 5	-	33	-	
Total Gate Charge	Qg			-	-	20	
Gate-Source Charge	Q_gs	V _{GS} = - 10 V		-	-	3.3	nC
Gate-Drain Charge	Q _{gd}			-	-	11	
Turn-On Delay Time	t _{d(on)}		·	-	8.8	-	
Rise Time	t _r	V _{DD} = -	- 100 V, I _D = - 3.9 A,	-	27	-	- ns
Turn-Off Delay Time	t _{d(off)}	$R_g = \overline{18} \Omega,$	$R_D = 24 \Omega$, see fig. 10^{b}	-	7.3	-	
Fall Time	t _f			-	19	-	
Internal Drain Inductance	L _D	Between lead 6 mm (0.25")	· ,	-	4.5	-	
Internal Source Inductance	L _S	package and die contact	center of	-	7.5	-	nH
Drain-Source Body Diode Characteristic	s	-					
Continuous Source-Drain Diode Current	IS	MOSFET sym showing the	bol	-	-	- 3.6	
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		-	-	- 14	A
Body Diode Voltage	V_{SD}	T _J = 25 °C,	I_{S} = - 3.6 A, V_{GS} = 0 V ^b	-	-	- 6.3	V
Body Diode Reverse Recovery Time	t _{rr}	T _ 05 °O I	- 20 A dl/dt 100 A/b	-	150	300	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 25 {}^{-} {\rm C}, I_{\rm F}$	= - 3.9 A, dl/dt = 100 A/μs ^b	-	0.97	2.0	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	ırn-on time is negligible (turn	-on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

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IRFR9220, IRFU9220, SiHFR9220, SiHFU9220

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

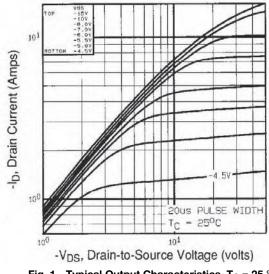


Fig. 1 - Typical Output Characteristics, T_C = 25 $^\circ C$

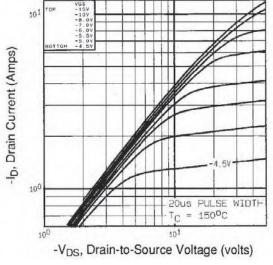
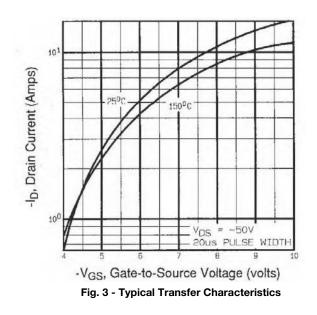


Fig. 2 - Typical Output Characteristics, T_C = 150 °C



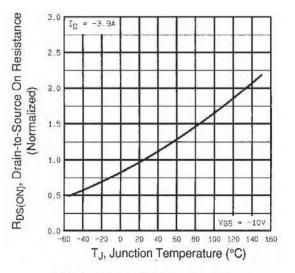


Fig. 4 - Normalized On-Resistance vs. Temperature



IRFR9220, IRFU9220, SiHFR9220, SiHFU9220

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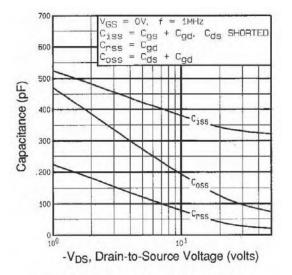


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

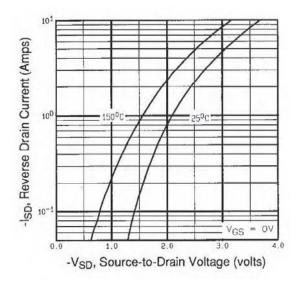


Fig. 7 - Typical Source-Drain Diode Forward Voltage

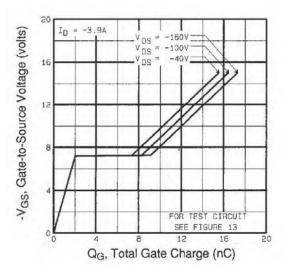


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

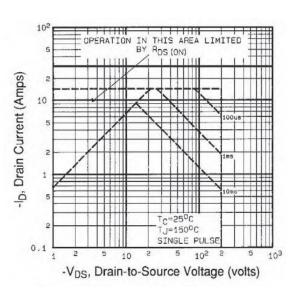


Fig. 8 - Maximum Safe Operating Area



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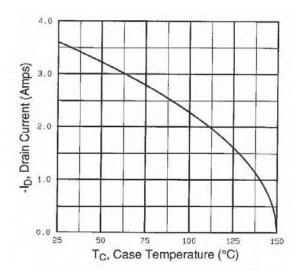


Fig. 9 - Maximum Drain Current vs. Case Temperature

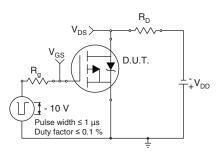


Fig. 10a - Switching Time Test Circuit

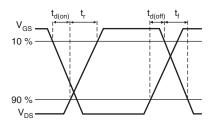


Fig. 10b - Switching Time Waveforms

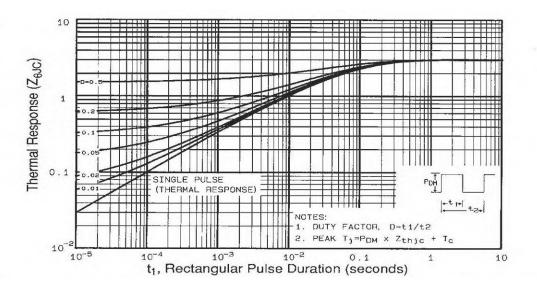


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case





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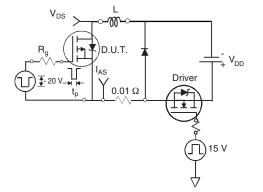


Fig. 12a - Unclamped Inductive Test Circuit

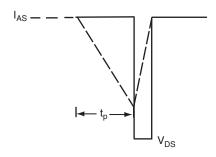


Fig. 12b - Unclamped Inductive Waveforms

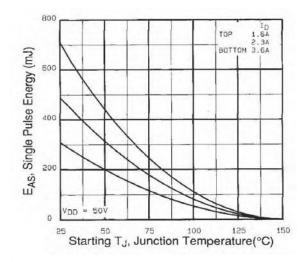
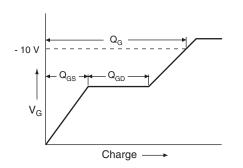


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





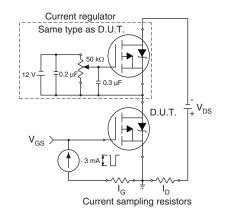


Fig. 13b - Gate Charge Test Circuit

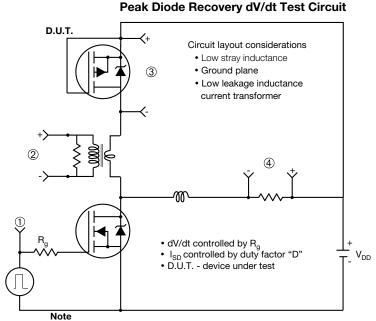
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• Compliment N-Channel of D.U.T. for driver

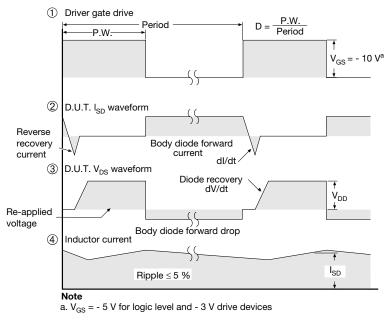
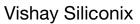


Fig. 14 - For P-Channel

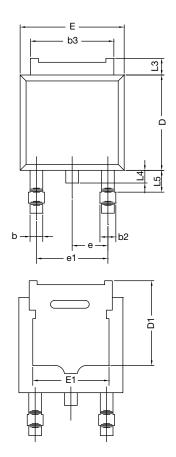
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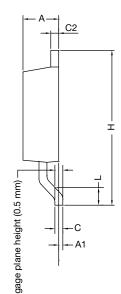
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TO-252AA Case Outline





	MILLIN	IETERS	INC	HES			
DIM.	MIN.	MAX.	MIN.	MAX.			
А	2.18	2.38	0.086	0.094			
A1	-	0.127	-	0.005			
b	0.64	0.88	0.025	0.035			
b2	0.76	1.14	0.030	0.045			
b3	4.95	5.46	0.195	0.215			
С	0.46	0.61	0.018	0.024			
C2	0.46	0.89	0.018	0.035			
D	5.97	6.22	0.235	0.245			
D1	4.10	-	0.161	-			
Е	6.35	6.73	0.250	0.265			
E1	4.32	-	0.170	-			
Н	9.40	10.41	0.370	0.410			
е	2.28	BSC	0.090 BSC				
e1	4.56	BSC	0.180 BSC				
L	1.40	1.78	0.055	0.070			
L3	0.89	1.27	0.035	0.050			
L4	-	1.02	-	0.040			
L5	1.01	1.52	0.040	0.060			
ECN: T16- DWG: 534	0236-Rev. P, [•] 7	16-May-16					

Notes

• Dimension L3 is for reference only.



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TO-251AA (HIGH VOLTAGE)



	MILLI	METERS	INC	HES		MILLI	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MA
А	2.18	2.39	0.086	0.094	D1	5.21	-	0.205	-
A1	0.89	1.14	0.035	0.045	E	6.35	6.73	0.250	0.2
b	0.64	0.89	0.025	0.035	E1	4.32	-	0.170	-
b1	0.65	0.79	0.026	0.031	е	2.29	BSC	2.29	BSC
b2	0.76	1.14	0.030	0.045	L	8.89	9.65	0.350	0.3
b3	0.76	1.04	0.030	0.041	L1	1.91	2.29	0.075	0.0
b4	4.95	5.46	0.195	0.215	L2	0.89	1.27	0.035	0.0
с	0.46	0.61	0.018	0.024	L3	1.14	1.52	0.045	0.0
c1	0.41	0.56	0.016	0.022	θ1	0'	15'	0'	15
c2	0.46	0.86	0.018	0.034	θ2	25'	35'	25'	35
D	5.97	6.22	0.235	0.245		•	•	•	

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.



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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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